

PXIe-6739

Specifications





Test & Measurement Automation

Embedded Control & Monitoring

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Authorized Distributor



Integration Partner

Contents

PXIe-6739		3
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PXIe-6739 Specifications

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Definitions

Warranted specifications describe the performance of a model under stated operating conditions and are covered by the model warranty.

Characteristics describe values that are relevant to the use of the model under stated operating conditions but are not covered by the model warranty.

- *Typical* specifications describe the performance met by a majority of models.
- **Nominal** specifications describe an attribute that is based on design, conformance testing, or supplemental testing.

Specifications are *Typical* unless otherwise noted.

Conditions

Specifications are valid at 25 °C unless otherwise noted.

PXIe-6739 Pinout

CONNECTOR 0 (AO 0-31)		ı			CTO 2–63					
		_	$\overline{}$)			_	$\overline{}$)	
Bank	AO GND 30/31	68	34	AO 31		AO GND 62/63	68	34	AO 63	AO
Ba	AO 30	67	33	AO GND 28/29		AO 62	67	33	AO GND 60/61) Bank
AO	AO 29	66	32	AO 28		AO 61	66	32	AO 60	媡
녿	AO GND 26/27	65	31	AO 27		AO GND 58/59	65	31	AO 59	≥
Bank	AO 26	64	30	AO GND 24/25		AO 58	64	30	AO GND 56/57	AO Bank
AO	AO 25	63	29	AO 24		AO 57	63	29	AO 56	泉
¥	AO GND 22/23	62	28	AO 23		AO GND 54/55	62	28	AO 55	➤
Bank	AO 22	61	27	AO GND 20/21		AO 54	61	27	AO GND 52/53	AO Bank
AO	AO 21	60	26	AO 20		AO 53	60	26	AO 52	an k
	AO GND 18/19	59	25	AO 19		AO GND 50/51	59	25	AO 51	
Bank	AO 18	58	24	AO GND 16/17		AO 50	58	24	AO GND 48/49	AO Bank
AO	AO 17	57	23	AO 16		AO 49	57	23	AO 48	an
	AO GND ¹	56	22	AO 15		AO GND ¹	56	22	AO 47	
Bank	AO GND 14/15	55	21	AO 14		AO GND 46/47	55	21	AO 46	AO Bank
AOE	AO 13	54	20	AO GND 12/13		AO 45	54	20	AO GND 44/45	Ban
	AO 12	53	19	AO GND ¹		AO 44	53	19	AO GND ¹	
Bank	AO 11	52	18	AO GND 11		AO 43	52	18	AO GND 43	AO Bank
	AO 10	51	17	AO 9		AO 42	51	17	AO 41	Bar
AO	AO GND 8/9/10	50	16	AO 8		AO GND 40/41/42	50	16	AO 40	ᅡ
Bank	AO GND 6/7	49	15	AO 7		AO GND 38/39	49	15	AO 39	A
	AO 6	48	14	AO GND 4/5		AO 38	48	14	AO GND 36/37	AO Bank
AO	AO 5	47	13	AO 4		AO 37	47	13	AO 36	흣
Bank	AO GND 2/3	46	12	AO 3		AO GND 34/35	46	12	AO 35	A
Ba	AO 2	45	11	AO GND 0/1		AO 34	45	11	AO GND 32/33	AO Bank
AO	AO 1	44	10	AO 0		AO 33	44	10	AO 32	Ě
	D GND ¹	43	9	PFI 7/P1.7		D GND ¹	43	9	PFI 15/P2.7	
	D GND PFI 6/7	42	8	PFI 6/P1.6		D GND PFI 14/15	42	8	PFI 14/P2.6	
	D GND PFI 4/5	41	7	PFI 5/P1.5		D GND PFI 12/13	41	7	PFI 13/P2.5	
	PFI 4/P1.4	40	6	PFI 3/P1.3		PFI 12/P2.4	40	6	PFI 11/P2.3	
	D GND PFI 2/3	39	5	PFI 2/P1.2		D GND PFI 10/11	39	5	PFI 10/P2.2	
	PFI 1/P1.1	38	4	PFI 0/P1.0		PFI 9/P2.1	38	4	PFI 8/P2.0	
	D GND PFI 0/1	37	3	P0.1		D GND PFI 8/9	37	3	P0.3	
	D GND P0.0/0.1	36	2	P0.0		D GND P0.2/0.3	36	2	P0.2	
	D GND ¹	35	1	+5 V		D GND ¹	35	1	+5 V	
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¹ No connect when using the SHC68-68-A2 cable.

Table 1. Default Counter/Timer Terminals

Counter/Timer Signal	Default PFI Terminal
CTR 0 SRC	PFI 5
CTR 0 GATE	PFI 6
CTR 0 AUX	PFI 4
CTR 0 OUT	PFI 7
CTR 0 A	PFI 5
CTR 0 Z	PFI 6
CTR 0 B	PFI 4
CTR 1 SRC	PFI 0
CTR 1 GATE	PFI 1

Counter/Timer Signal	Default PFI Terminal
CTR 1 AUX	PFI 3
CTR 1 OUT	PFI 2
CTR 1 A	PFI 0
CTR 1 Z	PFI 1
CTR 1 B	PFI 3
CTR 2 SRC	PFI 13
CTR 2 GATE	PFI 14
CTR 2 AUX	PFI 12
CTR 2 OUT	PFI 15
CTR 2 A	PFI 13
CTR 2 Z	PFI 14
CTR 2 B	PFI 12
CTR 3 SRC	PFI 8
CTR 3 GATE	PFI 9
CTR 3 AUX	PFI 11
CTR 3 OUT	PFI 10
CTR 3 A	PFI 8
CTR 3 Z	PFI 9
CTR 3 B	PFI 11

Table 2. Signal Descriptions

Signal	Reference	Description
AO <063>	AO GND	Analog Output Channels—These terminals supply voltage output.
AO GND	_	Analog Output

Signal	Reference	Description
		Ground—AO GND is the reference for the AO channels. When AO GND is listed next to an analog signal name, it is the dedicated ground reference for the listed signals (for example, AO GND 2/3 is the ground reference for AO 2 and AO 3). All ground references—AO GND and D GND—are connected on the device. Though AO GND and D GND are connected on the device, they are connected by small traces to reduce crosstalk between subsystems. Each ground may have a slight difference in potential.
D GND		Digital Ground—D GND supplies the reference for port 0, port 1, port 2 digital channels, PFI, and +5 V. When D GND is listed with a number, it is the dedicated ground reference for that PFI signal. All ground references—AO GND and D GND—are connected on the device. Though AO GND and D GND are connected on the device, they are connected by small traces to reduce crosstalk between subsystems. Each ground may have a slight difference in potential.
P0.<03>	D GND	Port 0 Digital I/O Channels—You can configure each signal

Signal	Reference	Description
		individually as an input or output.
+5 V	D GND	+5 V Power Source—These terminals provide a fused +5 V power source.
PFI <07>/P1.<07>, PFI <815>/P2.<07>	D GND	Programmable Function Interface or Digital I/O Channels—Each of these terminals can be individually configured as a PFI terminal or a digital I/O terminal. As an input, each PFI terminal can be used to supply an external source for AO, DI, and DO timing signals or counter/ timer inputs. As a PFI output, you can route many different internal AO, DI, or DO timing signals to each PFI terminal. You can also route the counter/ timer outputs to each PFI terminal. As a port 1 or port 2 digital I/O signal, you can individually configure each signal as an input or output.
NC	_	No connect—Do not connect signals to this terminal.

Analog Output

Number of channels	64 voltage outputs		
Resolution	16 bits, 1 in 65,536		
DNL	±1.0 LSB maximum		
Unscaled data format ¹	Unsigned integer (0 to 65,535)		
Monotonicity	16 bits		
Accuracy	Refer to the <i>AO Absolute Accuracy</i> table		
Maximum update rate (using local FIFO) ²			
1 channel		1 MS/s	
16 channels (1 channel per bank) ^{3 [3]}		1 MS/s	
64 channels ^[3]		350 kS/s	

- 1. Used for writing unscaled or raw data and covers the range from negative full scale (0) to positive full scale (65,535).
- 2. These numbers apply to continuous waveform generation using onboard memory only, which allows for the highest update rate by doing a single transfer of data over the bus. The maximum update rate in FIFO mode does not change regardless of the number of devices in the system.
- 3. All analog output channels are grouped into banks, as shown in your device pinout. Each bank consists of four AO channels using one DAC. Any channels being used within a single bank will update simultaneously.

Timing accuracy (warranted)	50 ppm of sample rate
Timing resolution	10 ns
Output range	±10 V
Output coupling	DC
Output impedance	0.2 Ω
Output current drive ⁴	±10 mA
Overdrive protection	±15 V
Overdrive current	15 mA
Power-on state	±200 mV
Power-on/off glitch	2.5 V peak for 100 ms
FIFO buffer size	65,535 samples shared among channels used
Data transfers	DMA (scatter-gather), programmed I/O

AO waveform modes

4. Analog output channels are designed for four-quadrant (source and sink) operation.

- Nonperiodic waveform
- Periodic waveform regeneration mode from onboard FIFO
- · Periodic waveform regeneration from host buffer including dynamic update

Settling time, full scale step	15 μs to ±4 LSB			
Slew rate	3.0 V/μs			
Noise	1.0 mV RMS, DC to 1 MHz			
AO update glitch				
Magnitude		3.0 mV		
Duration		10 μs		
Glitch energy		3 nVs		
Channel crosstalk	-65 dB with SHC68-68-A2 cable (generating a 10 V, 100 point sinusoidal at 100 kHz on the reference channel)			
Output stability	Any passive load			



Note AO update glitch is the glitch energy that occurs on all channels on the same bank as the result of a channel update, regardless of value. For example, if you update the value of AO 0, all channels within that bank AO <0..3> will experience this glitch regardless of whether their output voltages change.

Absolute Accuracy (Warranted)

Absolute accuracy at full-scale number is valid immediately following self calibration and assumes the device is operating within 10 °C of the last external calibration.

Table 3. AO Absolute Accuracy

Nominal Range Positive Full Scale	Nominal Range Negative Full Scale	Residual Gain Error (ppm of Reading)	Gain Tempco (ppm/°C)	Reference Tempco (ppm/°C)	Offset Tempco (ppm)	Residual Offset Error (ppm of Range)	INL Error (ppm of Range)	Absolute Accuracy at Full Scale (µV)
10	-10	109	12	1	4	95	64	2,940



Note Accuracies listed are valid for up to two years from the device external calibration.

AO Absolute Accuracy Equation

```
AbsoluteAccuracy = OutputValue (GainError) + Range (OffsetError)
AbsoluteAccuracy = OutputValue · (GainError) + Range · (OffsetError)
GainError = ResidualGainError + GainTempco · (TempChangeFromLastInternalCal) + ReferenceTempco · (TempChangeFromLastExternalCal)
GainError = ResidualGainError + GainTempco (TempChangeFromLastInternalCal) + ReferenceTempco (TempChangeFromLastExternalCal)
OffsetError = ResidualOffsetError + OffsetTempco · (TempChangeFromLastInternalCal) + INL_Error
OffsetError = ResidualOffsetError + OffsetTempco · (TempChangeFromLastInternalCal) + INL_Error
```

Digital I/O/PFI

Static Characteristics

Number of channels	20 total, 4 (P0.<03>), 16 (PFI<07>/P1.<07>, PFI <815>/P2.<07>)
Ground reference	D GND
Direction control	Each terminal individually programmable as input or output

Pull-down resistor	50 kΩ typical, 20 kΩ minimum
Input voltage protection ⁵	±20 V on up to two pins

Waveform Characteristics (Port 0 Only)

Terminals used		Port 0 (P0.<03>)
Port/sample size		Up to 4 bits
Waveform generation (DO) FIFO		2,047 samples
Waveform acquisition (DI) FIFO		255 samples
DI Sample Clock Frequency		0 to 10 MHz, system and bus activity dependent
DO Sample Clock frequency		
Regenerate from FIFO	0 to 1	10 MHz
Streaming from memory	0 to	10 MHz, system and bus activity dependent
Data transfers		DMA (scatter-gather), programmed I/O
Digital line filter settings		160 ns, 10.24 μs, 5.12 ms, disable

^{5.} Stresses beyond those listed under Input voltage protection may cause permanent damage to the device.

PFI/Port 1/Port 2 Functionality

Functionality	Static digital input, static digital output, timing input, timing output
Timing output sources	Many Al, AO, counter, DI, DO timing signals
Debounce filter settings	90 ns, 5.12 μs, 2.56 ms, custom interval, disable; programmable high and low transitions; selectable per input

Recommended Operating Conditions

Input high voltage (V _{IH})	2.2 V minimum, 5.25	5 V maximum
Input low voltage (V _{IL})	0 V minimum, 0.8 V	maximum
Output high current (I _{OH})		
P0.<03>		-24 mA maximum
PFI <015>/PI<07>/P2.<07>		-16 mA maximum
Output low current (I _{OL})		
P0.<03>		24 mA maximum
PFI <015>/P1<07>/P2.<07>		16 mA maximum

Electrical Characteristics

Level	Minimum	Maximum
Positive-going threshold (VT+)	_	2.2 V
Negative-going threshold (VT-)	0.8 V	_
Delta VT hysteresis (VT+ - VT-)	0.2 V	
I _{IL} input low current (V _{in} = 0 V)	_	-10 μΑ
I _{IH} input high current (V _{in} = 5 V)	_	250 μΑ

Digital I/O Characteristics

Figure 1. P0.<0..3>: I_{OH} versus V_{OH}

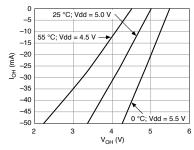


Figure 2. PFI <0..15>/PI/P2: I_{OH} versus V_{OH}

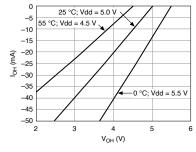


Figure 3. P0.<0..3>: I_{OL} versus V_{OL}

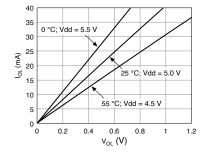
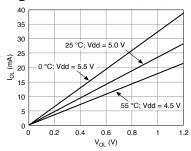


Figure 4. PFI <0..15>/P1/P2: I_{OL} versus V_{OL}



Timing I/O

Number of counter/timers	4
Resolution	32 bits
Counter measurements	Edge counting, pulse, pulse width, semi-period, period, two-edge separation
Position measurements	X1, X2, X4 quadrature encoding with Channel Z reloading; two-pulse encoding
Output applications	Pulse, pulse train with dynamic updates, frequency division, equivalent time sampling
Internal base clocks	100 MHz, 20 MHz, 100 kHz
External base clock frequency	0 MHz to 25 MHz
Base clock accuracy (warranted)	50 ppm

Inputs	Gate, Source, HW_Arm, Aux, A, B, Z, Up_Down, Sample Clock
Routing options for inputs	Any PFI, PXIe_DSTAR <a,b>, PXI_TRIG, PXI_STAR, many internal signals</a,b>
FIFO	127 samples per counter
Data transfers	Dedicated scatter-gather DMA controller for each counter/timer, programmed I/O

Phase-Locked Loop (PLL)

Table 4. Reference Clock Locking Frequencies

Reference Signal	Locking Input Frequency (MHz)
PXIe_DSTAR <a,b></a,b>	10, 20, 100
PXI_STAR	10, 20
PXIe-CLK100	100
PXI_TRIG <07>	10,20
PFI <015>	10,20

Outside of	100 MHz Timebase; other signals derived from 100 MHz Timebase including 20 MHz
PLL	and 100 kHz Timebases

External Digital Triggers

Source	Any PFI, PXIe_DSTAR <a,b>, PXI_TRIG, PXI_STAR</a,b>
Polarity	Software-selectable for most signals
Analog output function	Start Trigger, Pause Trigger, Sample Clock, Sample Clock Timebase
Counter/timer functions	Gate, Source, HW_Arm, Aux, A, B, Z, Up_Down, Sample Clock
Digital waveform generation (DO) function	Start Trigger, Pause Trigger, Sample Clock, Sample Clock Timebase
Digital waveform acquisition (DI) function	Start Trigger, Reference Trigger, Pause Trigger, Sample Clock, Sample Clock Timebase

Device-to-Device Trigger Bus

Input source	PXI_TRIG <07>, PXI_STAR, PXIe-DSTAR <a,b></a,b>
Output destination	PXI_TRIG <07>, PXIe_DSTARC
Output selections	10 MHz Clock; many internal signals

Debounce filter settings	90 ns, 5.12 μs , 2.56 ms, custom interval, disable; programmable high and low transitions; selectable per input
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Bus Interface

Form factor	x1 PXI Express peripheral module, specification rev 1.0 compliant
Slot compatibility	x1 and x4 PXI Express or PXI Express hybrid slots
DMA channels	7 DMA, analog output, digital input, digital output, counter/timer 0, counter/timer 1, counter/timer 2, counter/timer 3

Power Requirements



Notice The protection provided by the PXIe-6739 can be impaired if it is used in a manner not described in the user documentation.

+3.3 V	3.0 W
+12 V	20.8 W

Current Limits



Caution Exceeding the current limits may cause unpredictable behavior by the device and/or chassis.

+5 V terminal (connector 0)	1 A maximum ⁶ [6]
+5 V terminal (connector 1)	1 A maximum ^[6]
P0/P1/P2/PFI and +5 V terminals combined	1.4 A maximum

Physical

Dimensions (not including connectors)	16 cm x 10 cm (6.3 in. x 3.9 in.)
Weight	173 g (6.1 oz)
I/O connector	2 68-pin VHDCI

Calibration

Recommended warm-up time	15 minutes
Calibration interval	2 years

Safety Voltages

Connect only voltages that are below these limits.

6. Has a self-resetting fuse that opens when current exceeds this specification.

Channel-to-earth ground	±11 V, Measurement Category I
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Measurement Category I is for measurements performed on circuits not directly connected to the electrical distribution system referred to as MAINS voltage. MAINS is a hazardous live electrical supply system that powers equipment. This category is for measurements of voltages from specially protected secondary circuits. Such voltage measurements include signal levels, special equipment, limited-energy parts of equipment, circuits powered by regulated low-voltage sources, and electronics.

Measurement Category I is for measurements performed on circuits not directly connected to the electrical distribution system referred to as MAINS voltage. MAINS is a hazardous live electrical supply system that powers equipment. This category is for measurements of voltages from specially protected secondary circuits. Such voltage measurements include signal levels, special equipment, limited-energy parts of equipment, circuits powered by regulated low-voltage sources, and electronics.

Shock and Vibration

Operational shock	30 g peak, half-sine, 11 ms pulse (Tested in accordance with IEC 60068-2-27. Meets MIL-PRF-28800F Class 2 limits.)	
Random vibration		
Operating	5 to 500 Hz, 0.3 g RMS	
Nonoperating	5 to 500 Hz, 2.4 g RMS Nonoperating (Tested in accordance with IEC 60068-2-64. Nonoperating test profile exceeds the requirements of MIL-PRF-28800F, Class 3.)	

Environmental

Maximum altitude	2,000 m
Pollution Degree	2

Indoor use only.



Note Clean the device with a soft, non-metallic brush. Make sure that the device is completely dry and free from contaminants before returning it to service.

This product meets the requirements of the following environmental standards for electrical equipment for measurement, control, and laboratory use.

Operating Environment

Ambient temperature range	0 to 55 °C (Tested in accordance with IEC 60068-2-1 and IEC 60068-2-2. Meets MIL-PRF-28800FClass 3 low temperature limits and MIL-PRF-28800F Class 2 high temperature limit.)
Relative humidity range	10 to 90% RH, noncondensing (Tested in accordance with IEC 60068-2-56.)

Storage Environment

Ambient temperature range	-40 to 71 °C

Relative humidity range	5 to 95% RH, noncondensing
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Safety Compliance Standards

This product is designed to meet the requirements of the following electrical equipment safety standards for measurement, control, and laboratory use:

- IEC 61010-1, EN 61010-1
- UL 61010-1, CSA C22.2 No. 61010-1



Note For safety certifications, refer to the product label or the <u>Product</u> <u>Certifications and Declarations</u> section.

Electromagnetic Compatibility

This product meets the requirements of the following EMC standards for electrical equipment for measurement, control, and laboratory use:

- EN 61326-1 (IEC 61326-1): Class A emissions; Basic immunity
- EN 55011 (CISPR 11): Group 1, Class A emissions
- AS/NZS CISPR 11: Group 1, Class A emissions
- FCC 47 CFR Part 15B: Class A emissions
- ICES-001: Class A emissions



Note In the United States (per FCC 47 CFR), Class A equipment is intended for use in commercial, light-industrial, and heavy-industrial locations. In Europe, Canada, Australia and New Zealand (per CISPR 11) Class A equipment is intended for use only in heavy-industrial locations.



Note Group 1 equipment (per CISPR 11) is any industrial, scientific, or medical equipment that does not intentionally generate radio frequency energy for the treatment of material or inspection/analysis purposes.



Note For EMC declarations and certifications, and additional information, refer to the Online Product Certification section.

Product Certifications and Declarations

Refer to the product Declaration of Conformity (DoC) for additional regulatory compliance information. To obtain product certifications and the DoC for NI products, visit <u>ni.com/product-certifications</u>, search by model number, and click the appropriate link.

Environmental Management

NI is committed to designing and manufacturing products in an environmentally responsible manner. NI recognizes that eliminating certain hazardous substances from our products is beneficial to the environment and to NI customers.

For additional environmental information, refer to the **Engineering a Healthy Planet** web page at <u>ni.com/environment</u>. This page contains the environmental regulations and directives with which NI complies, as well as other environmental information not included in this document.

EU and UK Customers

• X Waste Electrical and Electronic Equipment (WEEE)—At the end of the product life cycle, all NI products must be disposed of according to local laws and regulations. For more information about how to recycle NI products in your region, visit ni.com/environment/weee.

电子信息产品污染控制管理办法(中国RoHS)

• ◎ ⑤ ● 中国RoHS — NI符合中国电子信息产品中限制使用某些有害物质指令 (RoHS)。关于NI中国RoHS合规性信息,请登录 ni.com/environment/ rohs china。 (For information about China RoHS compliance, go to ni.com/ environment/rohs china.)